MURA11573 mURA12073

Surface Mount Ultrafast Power Rectifiers

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

Features

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.71 V Max @ 1.0 A, $T_J = 150^{\circ}C$)
- Pb-Free Packages are Available

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 70 mg (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Protection: Human Body Model > 4000 V (Class 3) Machine Model > 400 V (Class C

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MURA115T3 MURA120T3	V _{RRM} V _{RWM} V _R	150 200	V
Average Rectified Forward Current @ $T_L = 155^{\circ}C$ @ $T_L = 135^{\circ}C$	I _{F(AV)}	1.0 2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	40	A
Operating Junction Temperature Range	ТJ	-65 to +175	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Lead $(T_L = 25^{\circ}C)$ (Note 1)	Psi _{JL} (Note 2)	24	°C/W
Thermal Resistance, Junction-to-Ambient (Note 1)	R_{\thetaJA}	216	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- 1. Rating applies when surface mounted on the minimum pad size recommended, PC Board FR-4.
- 2. In compliance with JEDEC 51, these values (historically represented by $R_{\theta JL}$) are now referenced as Psi_{JL} .



ON Semiconductor®

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ULTRAFAST RECTIFIERS 1 AMPERE, 100–200 VOLTS



SMA CASE 403D PLASTIC

MARKING DIAGRAM



U4x	= Device Code
	x = C for MURA115T3
	= D for MURA120T3

A = Assembly Location

- Y = Year
- WW = Work Week
- = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping [†]
MURA115T3	SMA	5000/Tape & Reel
MURA115T3G	SMA (Pb–Free)	5000/Tape & Reel
MURA120T3	SMA	5000/Tape & Reel
MURA120T3G	SMA (Pb-Free)	5000/Tape & Reel

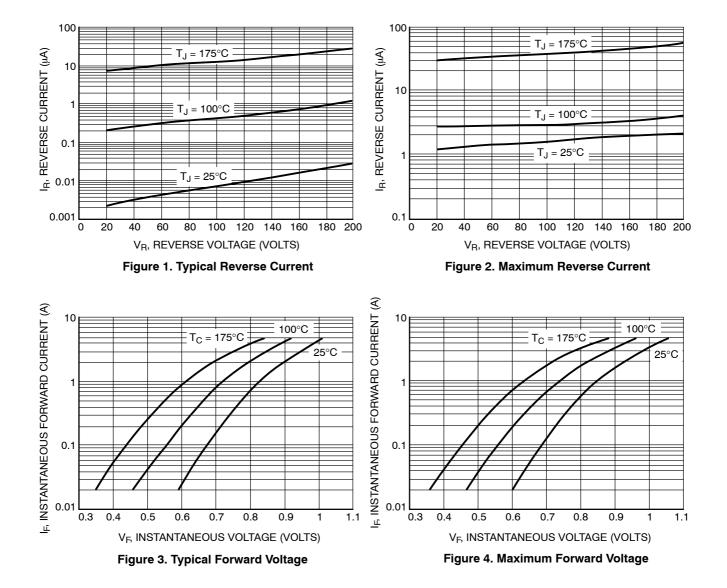
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MURA115T3, MURA120T3

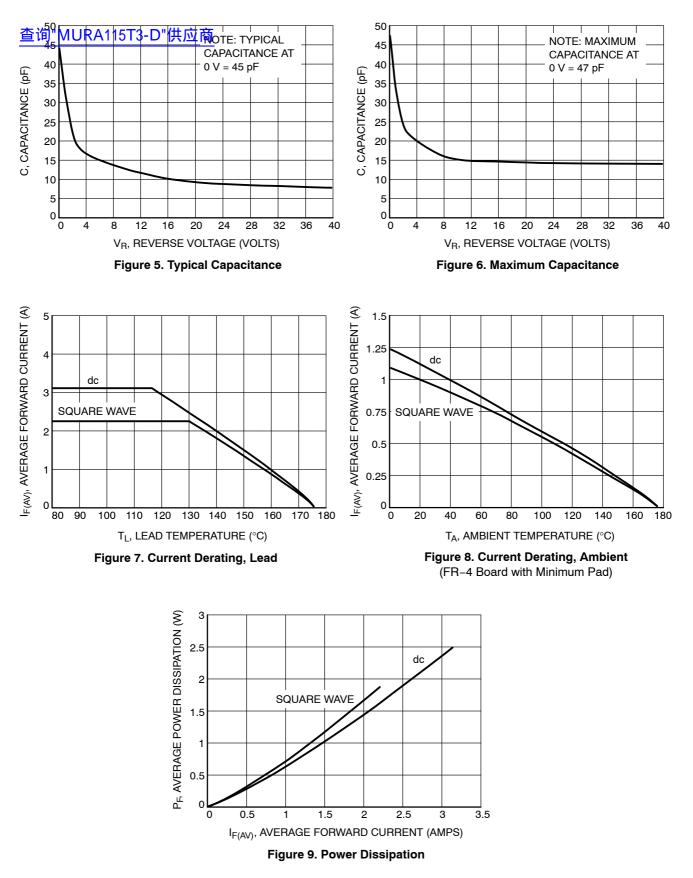
查询TRUCALACHARACT职应的

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (Note 3) ($i_F = 1.0 \text{ A}, T_J = 25^{\circ}\text{C}$) ($i_F = 1.0 \text{ A}, T_J = 150^{\circ}\text{C}$)	v _F	0.875 0.71	V
Maximum Instantaneous Reverse Current (Note 3) (Rated DC Voltage, $T_J = 25^{\circ}$ C) (Rated DC Voltage, $T_J = 150^{\circ}$ C)	İR	2.0 50	μΑ
Maximum Reverse Recovery Time (i _F = 1.0 A, di/dt = 50 A/μs)	t _{rr}	35	ns

3. Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.



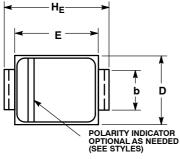
MURA115T3, MURA120T3

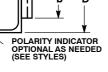


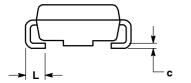
查询"MURA115T3-D"供应商

PACKAGE DIMENSIONS

SMA CASE 403D-02 **ISSUE F**









NOTES:

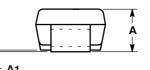
STYLE 1:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

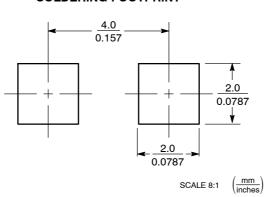
403D-01 OBSOLETE, NEW STANDARD IS 403D-02. З.

PIN 1. CATHODE (POLARITY BAND) 2. ANODE

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.97	2.10	2.20	0.078	0.083	0.087
A1	0.05	0.10	0.15	0.002	0.004	0.006
b	1.27	1.45	1.63	0.050	0.057	0.064
С	0.15	0.28	0.41	0.006	0.011	0.016
D	2.29	2.60	2.92	0.090	0.103	0.115
Е	4.06	4.32	4.57	0.160	0.170	0.180
HE	4.83	5.21	5.59	0.190	0.205	0.220
L	0.76	1.14	1.52	0.030	0.045	0.060



SOI DEBING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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